

# COM-HPC Solder Mode

COM-HPC Carrier Board Standoff



## Specification

Material	Stainless Steel
Surface Treatment	Tin Plated
Package	Bulk Package Reel Package

### Headquarter

10F-3, No. 270, Sec. 4,  
Chung Hsiao E. Rd.,  
Taipei, 10694, Taiwan

T +886 2 2751-7192  
E-mail: info@efco.com.tw

### EMEA

T +49-991-2009298-0  
E-mail: info@efcotec.com

### America

T +1-760-827-8600  
E-mail: sales-us@efcotec.com

**EFCO**  
EverFine Group

Note : All product specifications are subject to change without notice

# COM-HPC Solder Mode

---

## Asia Pacific

10F-3, No. 270, Sec 4, Chung Hsiao  
E. Road, Taipei, 10694, Taiwan  
Phone: +886-2-2751-7192  
Email: [info@efco.com.tw](mailto:info@efco.com.tw)

## EMEA

Ulrichsberger Str. 17, Haus G1,  
94469 Deggendorf, Germany  
Phone: +49-991-2009298-0  
Email: [sales@efcotec.de](mailto:sales@efcotec.de)

## Americas

570 W. Cheyenne Ave., Suite 210,  
North Las Vegas, NV 89030  
Phone: + 1-702-848-5320  
Email: [sales-us@efcotec.com](mailto:sales-us@efcotec.com)

## Headquarter

10F-3, No. 270, Sec. 4,  
Chung Hsiao E. Rd.,  
Taipei, 10694, Taiwan

T +886 2 2751-7192  
E-mail: [info@efco.com.tw](mailto:info@efco.com.tw)

## EMEA

T +49-991-2009298-0  
E-mail: [info@efcotec.com](mailto:info@efcotec.com)

## America

T +1-760-827-8600  
E-mail: [sales-us@efcotec.com](mailto:sales-us@efcotec.com)

